

SA data sheet SA-1064-25-500fs-x, λ = 1064 nm

Laser wavelength $\lambda = 1050 \text{ nm} \dots 1090 \text{ nm}$

Absorptance $A_0 = 25 \%$ Modulation depth $\Delta T = 13 \%$ Non-saturable loss $A_{ns} = 12 \%$

Saturation fluence $\Phi_{\text{sat}} = 300 \; \mu \text{J/cm}^2$ Damage threshold $\Phi = 1.2 \; \text{mJ/cm}^2$

Relaxation time constant $\tau \sim 500 \text{ fs}$

Chip area 5.0 mm x 5.0 mm; other dimensions on request

Chip thickness 625 µm; semi-insulating GaAs

Front side protection AR coating for 1064 nm

Back side coating the SA back side is polished and antireflection coated for 1064 nm

Mounting of SA-1064-24-500fs-x denotes the type of mounting as follows:

x = 0 unmounted

x = 12.7 g glued on a copper heat sink with 12.7 mm Ø and 4 mm Ø center hole x = 25.4 g glued on a copper heat sink with 25.4 mm Ø and 4 mm Ø center hole x = FC a back-thinned SA chip with 100 μm thickness is mounted inside a 1 m

monomode fiber cable

low intensity transmission, reflection and absorption

